

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Dustin P. Wood
Title: CHIP PACKAGE WITH DEGASSING HOLES
Attorney Docket No.: 884.159US2

J1064 U.S. PTO
09/800703
03/07/01

PATENT APPLICATION TRANSMITTAL

BOX PATENT APPLICATION

Commissioner for Patents
Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

- ☒ Return postcard.
☒ CONTINUATION of prior Patent Application No. 09/388,768 (under 37 CFR § 1.53(b)) comprising:
☒ Specification (19 pgs, including claims numbered 1 through 29 and a 1 page Abstract).
☒ Formal Drawing(s) (3 sheets).
☒ Copy of signed Combined Declaration and Power of Attorney (3 pgs) from prior application.
☒ Incorporation by Reference: *The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied herewith, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.*
☒ Check in the amount of \$800.00 to pay the filing fee.
☒ Prior application is assigned of record to Intel Corporation.
☒ Information Disclosure Statement (1 pgs), Form 1449 (1 pgs). References NOT enclosed, cited in prior application.
☒ Preliminary Amendment (6 pgs).

The filing fee has been calculated below as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	25 - 20 =	5	x 18 =	\$90.00
INDEPENDENT CLAIMS	3 - 3 =	0	x 80 =	\$0.00
[] MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$710.00
TOTAL				\$800.00

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This paper or fee is being deposited on the date indicated above with the United States Postal Service pursuant to 37 CFR 1.10, and is addressed to The Commissioner for Patents, Box Patent Application, Washington, D.C. 20231.